Panasonic

2SB1416

Silicon PNP epitaxial planar type

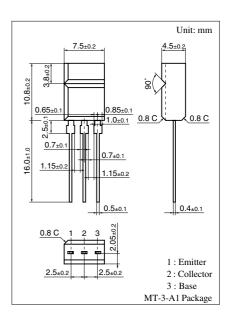
For low-frequency power amplification Complementary to 2SD2136

■ Features

- \bullet High forward current transfer ratio h_{FE} which has satisfactory linearity
- ullet Low collector to emitter saturation voltage $V_{\text{CE(sat)}}$
- Allowing automatic insertion with radial taping

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	-60	V
Collector to emitter voltage	V _{CEO}	-60	V
Emitter to base voltage	V _{EBO}	-5	V
Peak collector current	I _{CP}	-5	A
Collector current	I_{C}	-3	A
Collector power dissipation	P _C	1.5	W
Junction temperature	T_{j}	150	°C
Storage temperature	T_{stg}	-55 to +150	°C



■ Electrical Characteristics $T_C = 25$ °C

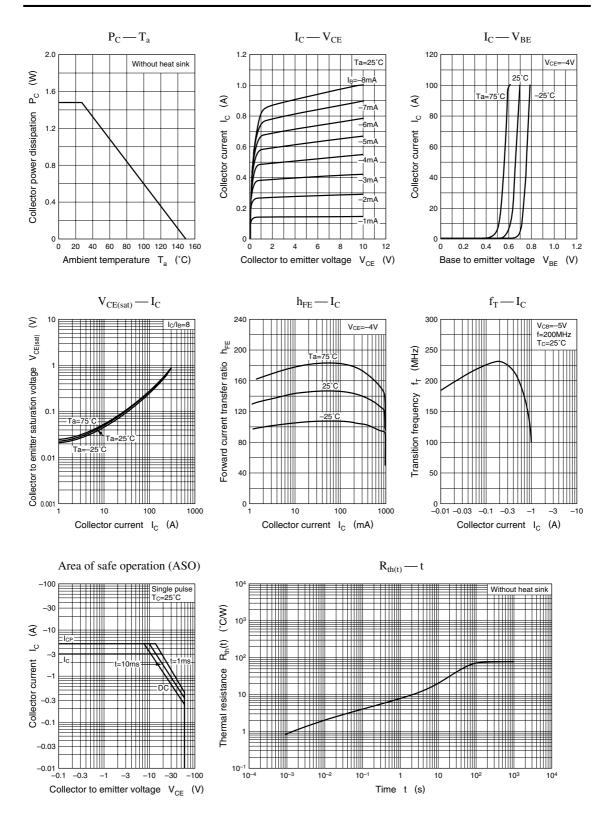
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I_{CES}	$V_{CE} = -60 \text{ V}, V_{BE} = 0$			-200	μΑ
	I_{CEO}	$V_{CE} = -30 \text{ V}, I_{B} = 0$			-300	μΑ
Emitter cutoff current	I_{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0$			-1	mA
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = -30 \text{ mA}, I_{\rm B} = 0$	-60			V
Forward current transfer ratio	h _{FE1} *	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	40		250	
	h _{FE2}	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$	10			
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = -3 \text{ A}, I_B = -0.375 \text{ A}$			-1.8	V
Base to emitter saturation voltage	V _{BE(sat)}	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$			-1.2	V
Transition frequency	f_T	$V_{CB} = -5 \text{ V}, I_E = 0.1 \text{ A}, f = 200 \text{ MHz}$			270	MHz
Turn-on time	t _{on}	$I_C = -1 A, I_{B1} = -0.1 A, I_{B2} = 0.1 A$		0.5		μs
Storage time	t _{stg}			1.2		μs
Fall time	t _f			0.3		μs

Note) *: Rank classification

Rank	Р	Q	R
h _{FE1}	40 to 90	70 to 150	120 to 250

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2SB1416 Power Transistors



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